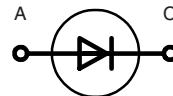
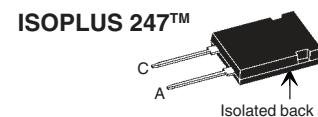


HiPerDynFRED™ Epitaxial Diode with soft recovery (Electrically Isolated Back Surface)

V_{RSM}	V_{RRM}	Type
V	V	
600	600	DSEP 30-06CR



$I_{FAV} = 30 \text{ A}$
 $V_{RRM} = 600 \text{ V}$
 $t_{rr} = 20 \text{ ns}$



A = Anode, C = Cathode

* Patent pending

Symbol	Conditions	Maximum Ratings		Features
I_{FRMS}		70	A	• Silicon chip on Direct-Copper-Bond substrates
I_{FAVM}	$T_C = 140^\circ\text{C}$; rectangular, $d = 0.5$	30	A	- High power dissipation
I_{FRM}	$t_p < 10 \mu\text{s}$; rep. rating, pulse width limited by T_{VJM}	tbd	A	- Isolated mounting surface
I_{FSM}	$T_{VJ} = 45^\circ\text{C}$; $t_p = 10 \text{ ms}$ (50 Hz), sine	300	A	- 2500 V electrical isolation
E_{AS}	$T_{VJ} = 25^\circ\text{C}$; non-repetitive $I_{AS} = 3 \text{ A}$; $L = 180 \mu\text{H}$	1.2	mJ	• Low cathode to tab capacitance (< 25 pF)
I_{AR}	$V_A = 1.5 \cdot V_R$ typ.; $f = 10 \text{ kHz}$; repetitive	0.3	A	• International standard package
T_{VJ}		-55...+175	°C	• Planar passivated chips
T_{VJM}		175	°C	• Very short recovery time
T_{stg}		-55...+150	°C	• Extremely low switching losses
P_{tot}	$T_C = 25^\circ\text{C}$	250	W	• Low I_{RM} -values
V_{ISOL}	50/60 Hz RMS; $I_{ISOL} \leq 1 \text{ mA}$	2500	V	• Soft recovery behaviour
F_c	mounting force with clip	20...120	N	• Epoxy meets UL 94V-0
Weight	typical	6	g	• Isolated and UL registered E153432

Symbol	Conditions	Characteristic Values		
		typ.	max.	
I_R ①	$T_{VJ} = 25^\circ\text{C}$ $V_R = V_{RRM}$ $T_{VJ} = 150^\circ\text{C}$ $V_R = V_{RRM}$	250	μA	
		1	mA	
V_F ②	$I_F = 30 \text{ A}$; $T_{VJ} = 150^\circ\text{C}$ $T_{VJ} = 25^\circ\text{C}$	2.25	V	• Antiparallel diode for high frequency switching devices
		3.07	V	• Antisaturation diode
R_{thJC}		0.6	K/W	• Snubber diode
R_{thCH}	with heatsink compound	0.25	K/W	• Free wheeling diode in converters and motor control circuits and PFC circuits
t_{rr}	$I_F = 1 \text{ A}$; $-di/dt = 200 \text{ A}/\mu\text{s}$; $V_R = 30 \text{ V}$; $T_{VJ} = 25^\circ\text{C}$	15	ns	• Rectifiers in switch mode power supplies (SMPS)
I_{RM}	$V_R = 100 \text{ V}$; $I_F = 50 \text{ A}$; $-di_F/dt = 100 \text{ A}/\mu\text{s}$ $T_{VJ} = 100^\circ\text{C}$	2.5	3.5	• Inductive heating

Pulse test: ① Pulse Width = 5 ms, Duty Cycle < 2.0 %
② Pulse Width = 300 μs , Duty Cycle < 2.0 %

Data according to IEC 60747 and per diode unless otherwise specified

Applications

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode in converters and motor control circuits and PFC circuits
- Rectifiers in switch mode power supplies (SMPS)
- Inductive heating
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders

Advantages

- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low I_{RM} reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commuting switch

Dimensions see Outlines.pdf

**Recommended replacement:
DPH30IS600HI**

IXYS reserves the right to change limits, test conditions and dimensions

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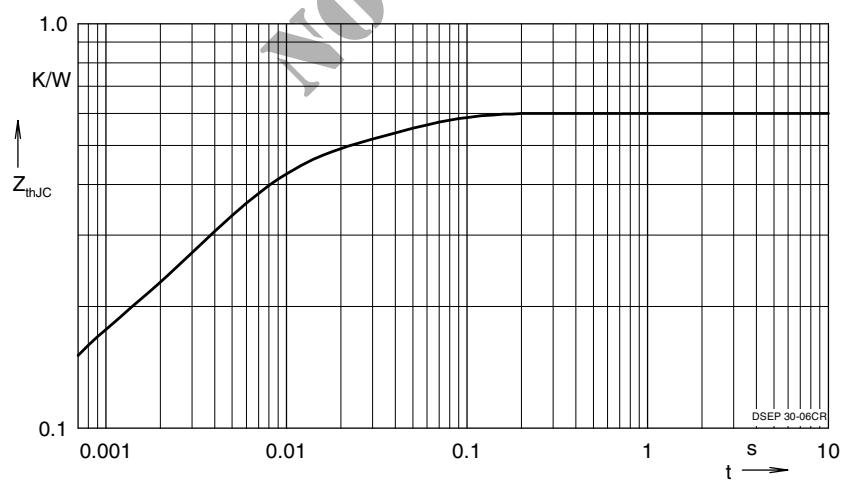


Fig. 7 Transient thermal resistance junction to case

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.31	0.005
2	0.1193	0.0003
3	0.1707	0.04